



#### 12V P-CHANNEL ENHANCEMENT MODE MOSFET

# **Product Summary**

| V <sub>(BR)DSS</sub> | R <sub>DS(ON) max</sub>         | I <sub>D MAX</sub><br>T <sub>A</sub> = +25°C |
|----------------------|---------------------------------|--|
| -12V                 | 0.8 Ω @ V <sub>GS</sub> = -4.5V |  |
|                      | 1.1 Ω @ V <sub>GS</sub> = -2.5V | -0.2A  |
|                      | 3.0 Ω @ V <sub>GS</sub> = -1.8V | -0.2A  |
|                      | 5.0 Ω @ V <sub>GS</sub> = -1.5V |  |

### **Description**

This MOSFET is designed to minimize the on-state resistance (R<sub>DS(ON)</sub>) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

### **Applications**

- Load Switch
- Power Management Functions
- Portable Power Adaptors







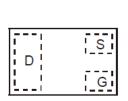
Bottom View

#### **Features**

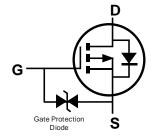
- 0.4mm Ultra Low Profile Package for Thin Application
- 0.48mm<sup>2</sup> Package Footprint, 16 Times Smaller than SOT23
- Low On-Resistance
- Low Input Capacitance
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

## **Mechanical Data**

- Case: X2-DFN0806-3
- Case Material: Molded Plastic, "Green" Molding Compound.
  UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @
- Weight: 0.00043 grams (Approximate)







Internal Schematic

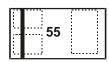
## Ordering Information (Note 4)

| Part Number   | Case         | Packaging          |
|---------------|--------------|--------------------|
| DMP1555UFA-7B | X2-DFN0806-3 | 10,000/Tape & Reel |

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

# **Marking Information**



Top View Bar Denotes Gate and Source Side

55 = Product Type Marking Code



## **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic                                     | Symbol           | Value           | Unit |   |
|--|------------------|-----------------|------|---|
| Drain-Source Voltage                               | V <sub>DSS</sub> | -12             | V    |   |
| Gate-Source Voltage                                | $V_{GSS}$        | ±8              | V    |   |
| Continuous Drain Current (V <sub>GS</sub> = -4.5V) | (Note 5)         | I <sub>D</sub>  | -0.2 | Α |
| Pulsed Drain Current (Note 6)                      |                  | I <sub>DM</sub> | -1.5 | Α |

# **Thermal Characteristics**

| Characteristic                          | Symbol                           | Value          | Units |      |
|---|----------------------------------|----------------|-------|------|
| Total Power Dissipation                 | (Note 5)                         | $P_{D}$        | 0.36  | W    |
| Thermal Resistance, Junction to Ambient | (Note 5)                         | $R_{	heta JA}$ | 353   | °C/W |
| Operating and Storage Temperature Range | T <sub>J,</sub> T <sub>STG</sub> | -55 to 150     | °C    |      |

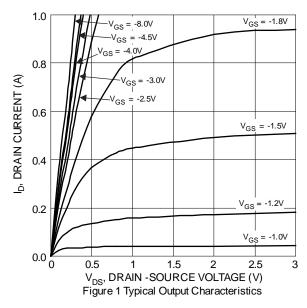
# **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic   | Symbol               | Min  | Тур  | Max  | Unit | Test Condition                                      |
|--|----------------------|------|------|------|------|---|
| OFF CHARACTERISTICS (Note 7)                           |                      |      |      |      |      |   |
| Drain-Source Breakdown Voltage                         | BV <sub>DSS</sub>    | -12  |      | _    | V    | $V_{GS} = 0V, I_D = -250\mu A$                      |
| Zero Gate Voltage Drain Current T <sub>J</sub> = +25°C | I <sub>DSS</sub>     | _    | _    | -1   | μA   | $V_{DS} = -10V, V_{GS} = 0V$                        |
| Gate-Source Leakage                                    | I <sub>GSS</sub>     | _    | _    | ±10  | μA   | $V_{GS} = \pm 8V, V_{DS} = 0V$                      |
| ON CHARACTERISTICS (Note 7)                            |                      |      |      |      |      |   |
| Gate Threshold Voltage                                 | V <sub>GS(th)</sub>  | -0.4 | _    | -1.0 | V    | $V_{DS} = V_{GS}, I_{D} = -250 \mu A$               |
|  |                      | _    | 0.4  | 0.8  | Ω    | $V_{GS} = -4.5V$ , $I_D = -0.2A$                    |
| Static Drain-Source On-Resistance                      | Б                    | _    | 0.55 | 1.1  |      | V <sub>GS</sub> = -2.5V, I <sub>D</sub> = -0.1A     |
| Static Drain-Source On-Resistance                      | R <sub>DS (ON)</sub> | _    | 0.75 | 3.0  |      | $V_{GS} = -1.8V, I_D = -0.05A$                      |
|  |                      | _    | 1.0  | 5.0  |      | $V_{GS} = -1.5V, I_D = -0.01A$                      |
| Diode Forward Voltage                                  | $V_{SD}$             | _    | _    | -1.2 | V    | $V_{GS} = 0V, I_{S} = -0.2A$                        |
| DYNAMIC CHARACTERISTICS (Note 8)                       |                      |      |      |      |      | •   |
| Input Capacitance                                      | C <sub>iss</sub>     | _    | 55.4 | _    | pF   |   |
| Output Capacitance                                     |                      | _    | 14.7 | _    | pF   | $V_{DS} = -10V, V_{GS} = 0V,$<br>- f = 1MHz         |
| Reverse Transfer Capacitance                           | C <sub>rss</sub>     | _    | 11.9 | _    | pF   | 1 = 11011 12  |
| Total Gate Charge (V <sub>GS</sub> = 4.5V)             | $Q_g$                | _    | 0.84 | _    | nC   |   |
| Gate-Source Charge                                     | Q <sub>gs</sub>      | _    | 0.12 | _    | nC   | $V_{DS} = -6V, V_{GS} = -4.5V,$<br>$-I_{D} = -0.2A$ |
| Gate-Drain Charge                                      | $Q_{gd}$             | _    | 0.23 | _    | nC   | 1D = -0.2A  |
| Turn-On Delay Time                                     | t <sub>D(on)</sub>   | _    | 16   | _    | ns   |   |
| Turn-On Rise Time                                      | tr                   | _    | 62   | _    | ns   | $V_{DD} = -6V, V_{GS} = -4.5V,$                     |
| Turn-Off Delay Time                                    | t <sub>D(off)</sub>  | _    | 232  | _    | ns   | $I_D = -0.2A$ , $R_G = 6\Omega$                     |
| Turn-Off Fall Time                                     | t <sub>f</sub>       | _    | 186  | _    | ns   |   |

Notes:

- 5. Device mounted on FR-4 PCB, with minimum recommended pad layout.
- 6. Device mounted on minimum recommended pad layout test board, 10µs pulse duty cycle = 1%.
- 7. Short duration pulse test used to minimize self-heating effect.
- 8. Guaranteed by design. Not subject to product testing.





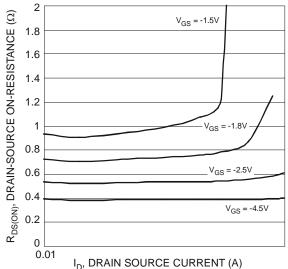
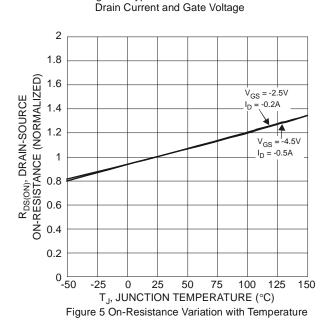
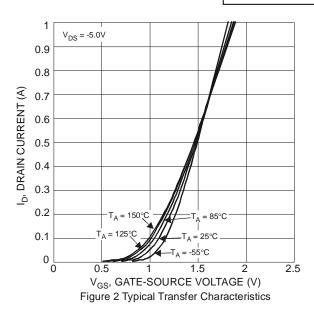
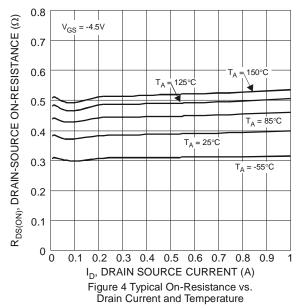


Figure 3 Typical On-Resistance vs.







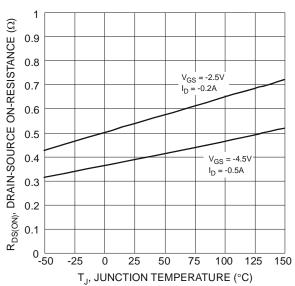


Figure 6 On-Resistance Variation with Temperature



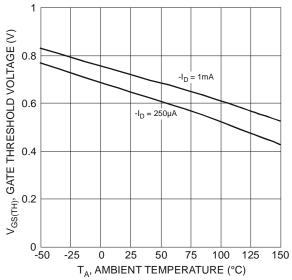
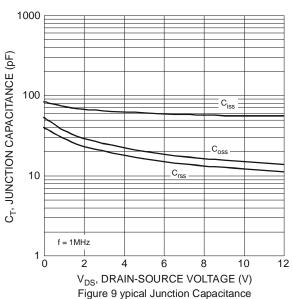
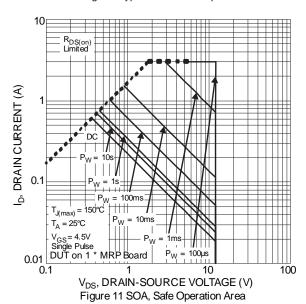
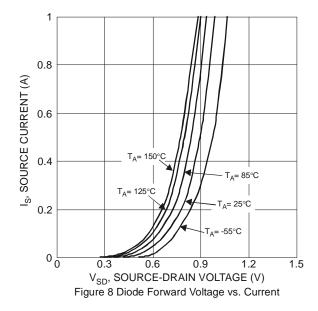
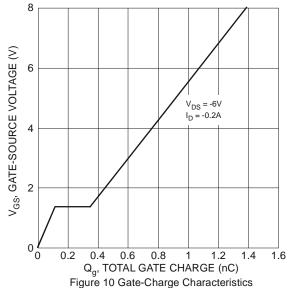


Figure 7 Gate Threshold Variation vs. Ambient Temperature

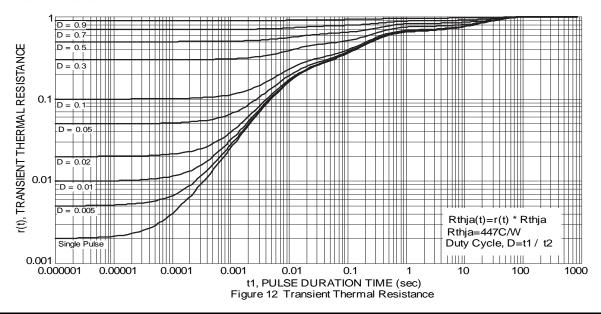






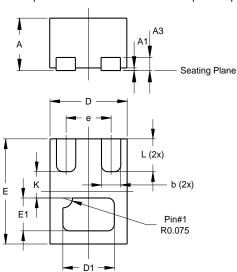






## **Package Outline Dimensions**

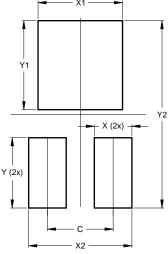
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



| X2-DFN0806-3         |       |      |      |  |  |
|----------------------|-------|------|------|--|--|
| Dim                  | Min   | Max  | Тур  |  |  |
| Α                    | 0.375 | 0.40 | 0.39 |  |  |
| A1                   | 0     | 0.05 | 0.02 |  |  |
| A3                   | -     | -    | 0.10 |  |  |
| b                    | 0.10  | 0.20 | 0.15 |  |  |
| D                    | 0.55  | 0.65 | 0.60 |  |  |
| D1                   | 0.35  | 0.45 | 0.40 |  |  |
| Е                    | 0.75  | 0.85 | 0.80 |  |  |
| E1                   | 0.20  | 0.30 | 0.25 |  |  |
| е                    | -     | -    | 0.35 |  |  |
| K                    | -     | -    | 0.20 |  |  |
| L                    | 0.20  | 0.30 | 0.25 |  |  |
| All Dimensions in mm |       |      |      |  |  |

# **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



| Dimensions | Value<br>(in mm) |  |  |
|------------|------------------|--|--|
| С          | 0.350            |  |  |
| Х          | 0.200            |  |  |
| X1         | 0.450            |  |  |
| X2         | 0.550            |  |  |
| Y          | 0.375            |  |  |
| Y1         | 0.475            |  |  |
| Y2         | 1.000            |  |  |



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